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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/657,402	09/08/2003	Shin-ichi Nishi	KOT-0081	9916
7590 05/05/2005		EXAMINER		
CANTOR COLBURN LLP			MRUK, GEOFFREY S	
55 Griffin Road South Bloomfield, CT 06002			ART UNIT	PAPER NUMBER
			2853	
			DATE MAIL ED. 05/05/200	<i>-</i>

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)				
	10/657,402	NISHI ET AL.				
Office Action Summary	Examiner	Art Unit				
	Geoffrey Mruk	2853				
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply						
A SHORTENED STATUTORY PERIOD FOR REP THE MAILING DATE OF THIS COMMUNICATION - Extensions of time may be available under the provisions of 37 CFR after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a re- If NO period for reply is specified above, the maximum statutory perions - Failure to reply within the set or extended period for reply will, by state Any reply received by the Office later than three months after the main earned patent term adjustment. See 37 CFR 1.704(b).	N. 1.136(a). In no event, however, may a reply be timely within the statutory minimum of thirty (30) days of will apply and will expire SIX (6) MONTHS from the cause the application to become ABANDONE	nely filed s will be considered timely. the mailing date of this communication. D (35 U.S.C. § 133).				
Status						
1)⊠ Responsive to communication(s) filed on 06	<u> April 2005</u> .					
	nis action is non-final.					
3) Since this application is in condition for allow	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is					
closed in accordance with the practice under	closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.					
Disposition of Claims						
4) ☐ Claim(s) 1-28 is/are pending in the application. 4a) Of the above claim(s) 19-28 is/are withdrawn from consideration. 5) ☐ Claim(s) is/are allowed. 6) ☐ Claim(s) 1-18 is/are rejected. 7) ☐ Claim(s) is/are objected to. 8) ☐ Claim(s) are subject to restriction and/or election requirement.						
Application Papers						
9) The specification is objected to by the Examination The drawing(s) filed on <u>08 September 2003</u> is Applicant may not request that any objection to the Replacement drawing sheet(s) including the correction. The oath or declaration is objected to by the	s/are: a)⊠ accepted or b)⊡ object ne drawing(s) be held in abeyance. See ection is required if the drawing(s) is obj	e 37 CFR 1.85(a). ected to. See 37 CFR 1.121(d).				
Priority under 35 U.S.C. § 119						
 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No. 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 						
Attachment(s) 1) Notice of References Cited (PTO-892)	4) 🔲 Interview Summary	(PTO.413)				
 Notice of References Cited (PTO-692) Notice of Draftsperson's Patent Drawing Review (PTO-948) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/0 Paper No(s)/Mail Date <u>10 December 2003</u>. 	Paper No(s)/Mail Da					

Application/Control Number: 10/657,402 Page 2

Art Unit: 2853

reply filed on 6 April 2005.

DETAILED ACTION

Election/Restrictions

Claims 19-28 are withdrawn from further consideration pursuant to 37 CFR
 1.142(b), as being drawn to a nonelected invention, there being no allowable generic or linking claim. Applicant timely traversed the restriction (election) requirement in the

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

1. Claims 1 and 2 are rejected under 35 U.S.C. 103(a) as being unpatentable over Ison (WO 01/60627 A2) in view of Yokono et al. (US 5,133,403).

With respect to claim 1, the primary reference of Ison discloses an inkjet recording head (Fig. 9, element 1100) for ejecting ink in ink channels by deformation of the piezoelectric element (Fig. 9, element 1110), comprising:

a partition wall (Fig. 9, element 1180), at least a part of which is formed with a
piezoelectric element, for partitioning a plurality of tubular ink channels (Fig. 9,
element 1130);

 a top wall (Fig. 9, element 1140) for forming a top surface of the plurality of tubular ink channels by shielding an upper part of the plurality of tubular ink channels;

- a bottom wall (page 13, line 30, i.e. perspective view of part of a printhead) for forming a bottom surface of the plurality of tubular ink channels by shielding the bottom part of the plurality of tubular ink channels;
- wherein, at least a part of the top wall and the bottom wall is made of AIN (page
 7, lines 29-36).

Ison fails to disclose at least a part of the top wall and the bottom wall is made of AIN-BN.

The secondary reference of Yokono discloses a "thermoconductive cooling element 3 formed of a composite sintered material consisting essentially of AIN and BN" (Column 5, lines 32-57).

With respect to claim 2, the primary reference of Ison discloses the part of the top wall (Fig. 12, element 1140) and the bottom wall made of AIN is thermally connected to a heat sink (Fig. 12, element 1200).

Therefore, in view of the teachings of the secondary reference, one of ordinary skill in the art would have been motivated to modify the primary reference by using the AIN-BN material of Yokono for the top and bottom wall. The motivation for doing so would have been to "to reduce the thermal resistance to a great extent as compared with a composite material of AIN" (Column 6, lines 1-5).

2. Claims 3 and 4 are rejected under 35 U.S.C. 103(a) as being unpatentable over Ison (WO 01/60627 A2) in view of Yokono et al. (US 5,133,403) as applied to claims 1 and 2 above, and further in view of Fessenden (US 5,895,973).

Ison and Yokono references disclose all of the limitations of the inkjet recording head except the part of the top wall and the bottom wall is adhered to the heat sink via an epoxy type adhesive agent including Ag particles and the layer thickness of the epoxy type adhesive agent is 50 to 70 μ m.

Fessenden discloses a "ceramic substrate is preferably 96% alumina and has a thickness of approximately 0.035 inch and is attached to the top of the heat sink 12 by a layer of thermally conductive adhesive 60 having a thickness in the range of approximately 0.002 inch to approximately 0.012 inch" (Column 8, lines 14-23).

Therefore, in view of the teachings of the tertiary reference, one of ordinary skill in the art would have been motivated to modify the primary reference by using the thermally conductive adhesive of Fessenden to adhere the top and bottom wall to the heat sink. The motivation for doing so would have been to dissipate heat (Column 8, lines 9-23).

3. Claim 5 is rejected under 35 U.S.C. 103(a) as being unpatentable over Ison (WO 01/60627 A2) in view of Yokono et al. (US 5,133,403) as applied to claims 1 and 2 above, and further in view of Hara et al. (US 4,296,421).

Ison and Yokono references disclose all of the limitations of the inkjet recording head except that the thickness of the heat sink is 1.0 to 10.0mm.

Hara discloses a "Cu plating of 1mm in thickness is provided as a heat sink 28" (Column 8, lines 27-28).

Therefore, in view of the teachings of the tertiary reference, one of ordinary skill in the art would have been motivated to modify the primary reference by using the heat sink thickness of Hara in the inkjet recording head. The motivation for doing so would have been to "improve the heat release in the heat generating member portion" (Column 8, lines 25-27).

4. Claims 6-9 are rejected under 35 U.S.C. 103(a) as being unpatentable over Ison (WO 01/60627 A2) in view of Yokono et al. (US 5,133,403) as applied to claims 1 and 2 above, and further in view of Deshpande et al. (US 4,831,390).

Ison and Yokono references disclose all of the limitations of the inkjet recording head except

- the top wall and the bottom wall made of AIN-BN is adhered to the partition wall via an epoxy type adhesive agent including particles of one of aluminum-nitride, alumina and silica;
- a layer thickness of the epoxy type adhesive agent including particles of one of aluminum-nitride, alumina and silica is 5 to 10 μm;
- the heat sink is provided on a carriage, on which the inkjet recording head is installed; and
- the heat sink is thermally connected to a carriage, on which the inkjet recording head is installed.

Deshpande discloses "It is understood that the epoxy layer 40 is selected for high thermal conductivity and is applied in a thin layer" (Column 4, lines 1-26) and "the cartridge with its resultant R_{CART} acts as an effective heat sink or heat dissipater through convection. The effectiveness can be enhanced by decreasing the resistance. One method is to add particles of a thermally conductive material such as a ceramic (e.g. alumina or aluminum nitride) or metals such as powdered aluminum into the plastic metal used during cartridge formation. Another way is to add a heat sink member directly onto the cartridge surface as shown in FIG. 11. For this embodiment, heat sink 60 is bonded to the surface of cartridge 12" (Column 5, lines 24-35).

Therefore, in view of the teachings of the tertiary reference, one of ordinary skill in the art would have been motivated to modify the primary reference by using the teachings of Deshpande in the inkjet recording head. The motivation for doing so would have been to "augment the value of Q_s creating enhanced heat flow away from the print head and into air" (Column 5, lines 18-20). Also, it would have been obvious to one of ordinary skill in the art at the time the invention was made to incorporate the layer thickness of the epoxy type adhesive agent is 5 to 10 μ m, since it has been held that it is not inventive to discovering and optimum value or workable ranges by routine experimentation. *In re Aller*, 105 USPQ 233 (CCPA 1955).

5. Claims 10 and 11 are rejected under 35 U.S.C. 103(a) as being unpatentable over Ison (WO 01/60627 A2) in view of Yokono et al. (US 5,133,403).

With respect to claim 10, the primary reference of Ison discloses an inkjet recording head (Fig. 9, element 1100) for ejecting ink in ink channels by deformation of the piezoelectric element (Fig. 9, element 1110), comprising:

- a partition wall (Fig. 9, element 1180) for partitioning the plurality of tubular ink channels;
- a top wall (Fig. 9, element 1140) for forming a top surface of a plurality of tubular ink channels by shielding an upper part of the plurality of tubular ink channels;
- a bottom wall (page 13, line 30, i.e. perspective view of part of a printhead) for forming a bottom surface of the plurality of tubular ink channels by shielding the bottom part of the plurality of tubular ink channels;
- wherein, at least a part of the top wall and the bottom wall is formed of a
 piezoelectric element (Fig. 9, element 1110, i.e. boundary between elements
 1110 and 1140); and
- at least a part of the top wall and/or the bottom wall is made of AlN (page 7, lines 29-36).

Ison fails to disclose at least a part of the top wall and the bottom wall is made of AIN-BN.

The secondary reference of Yokono discloses a "thermoconductive cooling element 3 formed of a composite sintered material consisting essentially of AIN and BN" (Column 5, lines 32-57).

With respect to claim 11, the primary reference of Ison discloses the part of the top wall (Fig. 12, element 1140) and the bottom wall made of AIN is thermally connected to a heat sink (Fig. 12, element 1200).

Therefore, in view of the teachings of the secondary reference, one of ordinary skill in the art would have been motivated to modify the primary reference by using the AIN-BN material of Yokono for the top and bottom wall. The motivation for doing so would have been to "to reduce the thermal resistance to a great extent as compared with a composite material of AIN" (Column 6, lines 1-5).

6. Claims 12 and 13 are rejected under 35 U.S.C. 103(a) as being unpatentable over Ison (WO 01/60627 A2) in view of Yokono et al. (US 5,133,403) as applied to claims 10 and 11 above, and further in view of Fessenden (US 5,895,973).

Ison and Yokono references disclose all of the limitations of the inkjet recording head except the part of the top wall and the bottom wall is adhered to the heat sink via an epoxy type adhesive agent including Ag particles and the layer thickness of the epoxy type adhesive agent is 50 to 70 μ m.

Fessenden discloses a "ceramic substrate is preferably 96% alumina and has a thickness of approximately 0.035 inch and is attached to the top of the heat sink 12 by a layer of thermally conductive adhesive 60 having a thickness in the range of approximately 0.002 inch to approximately 0.012 inch" (Column 8, lines 14-23).

Therefore, in view of the teachings of the tertiary reference, one of ordinary skill in the art would have been motivated to modify the primary reference by using the thermally conductive adhesive of Fessenden to adhere the top and bottom wall to the

Application/Control Number: 10/657,402

Art Unit: 2853

heat sink. The motivation for doing so would have been to dissipate heat (Column 8, lines 9-23).

7. Claim 14 is rejected under 35 U.S.C. 103(a) as being unpatentable over Ison (WO 01/60627 A2) in view of Yokono et al. (US 5,133,403) as applied to claims 1 and 2 above, and further in view of Hara et al. (US 4,296,421).

Ison and Yokono references disclose all of the limitations of the inkjet recording head except that the thickness of the heat sink is 1.0 to 10.0mm.

Hara discloses a "Cu plating of 1mm in thickness is provided as a heat sink 28" (Column 8, lines 27-28).

Therefore, in view of the teachings of the tertiary reference, one of ordinary skill in the art would have been motivated to modify the primary reference by using the heat sink thickness of Hara in the inkjet recording head. The motivation for doing so would have been to "improve the heat release in the heat generating member portion" (Column 8, lines 25-27).

8. Claims 15-18 are rejected under 35 U.S.C. 103(a) as being unpatentable over Ison (WO 01/60627 A2) in view of Yokono et al. (US 5,133,403) as applied to claims 10 and 11 above, and further in view of Deshpande et al. (US 4,831,390).

Ison and Yokono references disclose all of the limitations of the inkjet recording head except

 the top wall and the bottom wall formed of a piezoelectric element, via an epoxy type adhesive agent including particles of one of aluminum-nitride, alumina and silica;

 a layer thickness of the epoxy type adhesive agent including particles of one of aluminum-nitride, alumina and silica is 5 to 10 μm

- the heat sink is provided on a carriage, on which the inkjet recording head is installed; and
- the heat sink is thermally connected to a carriage, on which the inkjet recording head is installed.

Deshpande discloses "It is understood that the epoxy layer 40 is selected for high thermal conductivity and is applied in a thin layer" (Column 4, lines 1-26) and "the cartridge with its resultant R_{CART} acts as an effective heat sink or heat dissipater through convection. The effectiveness can be enhanced by decreasing the resistance. One method is to add particles of a thermally conductive material such as a ceramic (e.g. alumina or aluminum nitride) or metals such as powdered aluminum into the plastic metal used during cartridge formation. Another way is to add a heat sink member directly onto the cartridge surface as shown in FIG. 11. For this embodiment, heat sink 60 is bonded to the surface of cartridge 12" (Column 5, lines 24-35).

Therefore, in view of the teachings of the tertiary reference, one of ordinary skill in the art would have been motivated to modify the primary reference by using the teachings of Deshpande in the inkjet recording head. The motivation for doing so would have been to "augment the value of Q_s creating enhanced heat flow away from the print head and into air" (Column 5, lines 18-20). Also, it would have been obvious to one of ordinary skill in the art at the time the invention was made to incorporate the layer thickness of the epoxy type adhesive agent is 5 to 10 μ m, since it has been held that it

is not inventive to discovering and optimum value or workable ranges by routine experimentation. *In re Aller,* 105 USPQ 233 (CCPA 1955).

Conclusion

The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Ting et al. (US 3,748,439) discloses a thermally conductive adhesive where "In order to improve heat transfer from element 12 to the first heat sink plate 14 it is preferred to attach the element by using a thin layer 22 of electrically and thermally conductive epoxy such as C-409 of Amicon Corporation, Lexington, Massachusetts, an epoxy having approximately 60 to 70 percent of silver by weight" (Column 3, lines 38-47).

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Geoffrey Mruk whose telephone number is (571) 272-2810. The examiner can normally be reached on 7am - 330pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Stephen Meier can be reached on (571) 272-2149. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Application/Control Number: 10/657,402 Page 12

Art Unit: 2853

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

GSM 4/27/2005

GM

MANISH S. SHAH PRIMARY EXAMINER

5/2/05